

OIT29C

3-ch. phototransistor array 0.60mm optical pitch on plastic SMD package

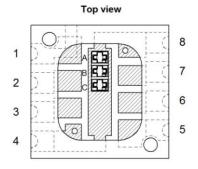
General Description

Applications

OIT29 consists in a three elements silicon phototransistor's monolithic array.

The phototransistors have a common collector, every emitter is available as a pad. The pitch of the silicon arrays is 0.6 mm, while the component electrical pitch is 1.27 mm. The active area of each element is 0.2 x 0.45 mm. The encapsulant is an high quality microelectronic transparent silicone resin: its transmission value is greater than 95% between 300nm and 400nm while it is very close to 100% in the range 400-900nm. The phototransistors have an antireflective coating that guarantees a good spectral bandwith (500-950nm) with a peak responsivity at 755nm. The main advantages of this device are the high uniformity of the silicon sensors in all elctro-optical parameters, due to the monolithic construction and the high optical responsivity, due to the antireflective coating deposited on the phototransistor's areas.

Optical encoders Incremental encoders Optical Receivers Controls/drives





Features

- High uniformity of silicon cells
- High transparency resin
- High gain
- Very small dimensions
- Reference dots on gold layer for very precise alignment

Reference holes on frame for mechanical alignment

Pin Functions

No.	Name	Function
1	AE	Phototransistor A Emitter
2	CE	Phototransistor C Emitter
3	N.C.	Not Connected
4	CC	Common collector
5	N.C.	Not Connected
6	N.C.	Not Connected
7	BE	Phototransistor B Emitter
8	CC	Common collector

TOP VIEW

Ordering information

OIT29

3-ch. phototransistor array 0.60mm optical pitch on plastic SMD package

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Min	Max	Unit
T _A	Operating Temperature Range	-40	85	°C
Ts	Storage Temperature	-40	100	°C
T _{Sol}	Lead Temperature (solder) 3s		360	°C
V _{R(BR)}	Breakdown Voltage Collector-Emitter @ T _A =25°C I _B =100nA I _C =1mA	50		V
PD	Power Dissipation @ T _A =25°C		150	mW
ESDS	Electrostatic Discharge Susceptibility (Human Body Model, ESCC20800)		3	class

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rated conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $T_A = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
ID	Dark Current	V _R =10V		5	100	nA
R _λ	Responsivity	V_{CE} =5V λ =755nm	0.5			A/W
λρ	Peak Responsivity	V _{CE} =5V		755		nm
Δλ	Spectral Bandwidth @ 50%	V _{CE} =5V	500		950	nm
I _{ec0}	Reverse Emitter to Collector Current	V _{EC} =7.7V		0.1	100	μA
I _{ce0}	Collector-Emitter Current	V _{CE} =52V		0.1	100	μA
H_{FE}	Gain	V _{cc} =5V I _c =2mA	500	1000	2000	-
V _{CE(sat)}	Saturation Voltage	I _E =2mA I _B =20μA		80	250	mV
I _{C(on)}	On-state Collector Current	V _{CE} =5V E _E =1.0mW/cm ²		1		mA
ΔI_{c}	Interchannel variation	V _{CE} =5V E _E =1.0mW/cm ²	-30		+30	%

AC SWITCHING CHARACTERISTICS

 $T_A = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _R	Rise Time	V_{CC} =5V I_C =1mA R_1 =1k Ω		10		μs
t _F	Fall Time	V_{CC} =5V I_C =1mA R_1 =1k Ω		11		μs

MECHANICAL CHARACTERISTICS

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
А	Phototransistor Active Area			0.09		mm ²
L	Length of the Active Area			0.2		mm
W	Width of the Active Area			0.45		mm

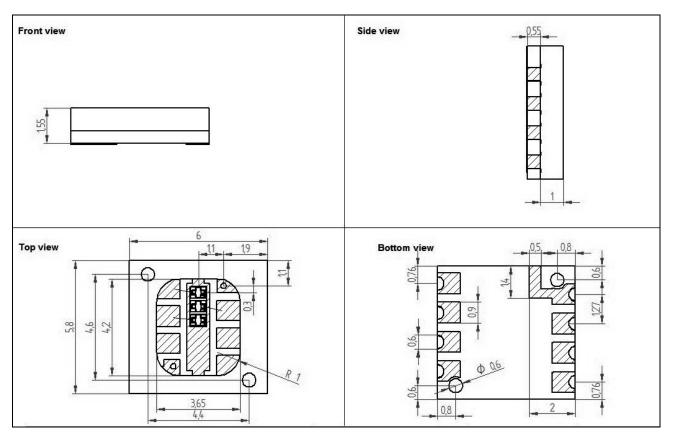
PACKAGE CHARACTERISTICS

Symbol	Parameter	Value	Unit
SF	Pad Surface Finishing	GOLD	
S∟	Pad Shelf Life	6	months
MSL	Moisture Sensitive Level ‡ (see note at bottom page)	3	Level



MECHANICAL DIMENSIONS

Units=mm Mechanical tolerance=+/-0.2mm Die positioning tolerance=±0.050mm



TYPICAL PERFORMANCE CURVES

Figure 1 – Output voltage Vs Temperature

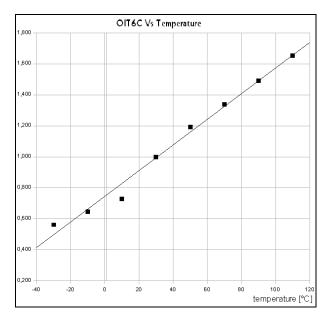


Figure 2 – Normalized spectral responsitivity

